



Product Change Notice

PCN Number: 15-0727-01
Issue Date: 09-FEBRUARY-2016

Exar Corporation

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PRODUCTS AFFECTED:	SP3239EEA-L/TR	SP3239EEA-L	SP3239ECA-L/TR	SP3239ECA-L
	SP3221EEY-L/TR	SP3221EEY-L	SP3221EEA-L/TR	SP3221EEA-L
	SP3221ECY-L/TR	SP3221ECY-L	SP3221ECA-L/TR	SP3221ECA-L
	SP3220EEY-L/TR	SP3220EEY-L	SP3220EEA-L/TR	SP3220EEA-L
	SP3220ECY-L/TR	SP3220ECY-L	SP3220ECA-L/TR	SP3220ECA-L
	SP3220EBEY-L/TR	SP3220EBEY-L	SP3220EBEA-L/TR	SP3220EBEA-L
	SP3220EBCY-L/TR	SP3220EBCY-L	SP3220EBCA-L/TR	SP3220EBCA-L

CHANGE CATEGORY:

- Material
 Process
 Package
 Design
 Datasheet
 Packing/Shipping
 Other: Foundry 6 inch wafer qualification

DESCRIPTION OF CHANGE:

Addition of qualified 6 inch wafer processing line in Silan, in addition to the currently qualified 5 inch wafer processing line.

IMPACT OF CHANGE:

There is no change to product form, fit or function.

TARGET IMPLEMENTATION DATE: 09-MAY-2016

Please contact customer support (customersupport@exar.com) for sample date availability or qualification data

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